

PNP Low Saturation Transistor

FZT790A

Description

These devices are designed with high current gain and low saturation voltage with collector currents up to 3 A continuous.

Features

 These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

ABSOLUTE MAXIMUM RATINGS (Notes 1, 2)

(Values are at T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	-40	V
Collector-Base Voltage	V_{CBO}	-50	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current – Continuous	I _C	-3	Α
Operating and Storage Junction Temperature Range	T _J , T _{STG}	-55 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

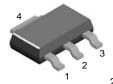
- 1. These ratings are based on a maximum junction temperature of 150°C.
- These are steady-state limits. onsemi should be consulted on applications involving pulsed or low-duty-cycle operations.

THERMAL CHARACTERISTICS (Note 3)

(Values are at T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Total Power Dissipation	P_{D}	2	W
Dissipation Derate Above 25°C	P_{D}	16	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	62.5	°C/W

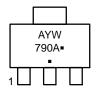
3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.



- 1. Base
- 2., 4. Collector
- Emitter

SOT-223 CASE 318H

MARKING DIAGRAM



A = Assembly Location

Y = Year

W = Work Week

790A = Specific Device Code

= Pb-Free Package(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FZT790A

ELECTRICAL CHARACTERISTICS

(Values are at $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Max.	Unit
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = -10 \text{ mA}, I_B = 0$	-40		V
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = -100 \mu A, I_E = 0$	-50		V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = -100 \mu\text{A}, I_C = 0$	-5.0		V
I _{CBO}	Collector Cut-Off Current	$V_{CB} = -30 \text{ V}, I_{E} = 0$		-100	nA
		$V_{CB} = -30 \text{ V}, I_E = 0, T_A = 100^{\circ}\text{C}$		-10	μΑ
I _{EBO}	Emitter Cut-Off Current	$V_{EB} = -4 \text{ V}, I_C = 0$		-100	nA
h _{FE}	DC Current Gain (Note 4)	$V_{CE} = -2.0 \text{ V}, I_{C} = -10 \text{ mA}$	300		
		$V_{CE} = -2.0 \text{ V}, I_{C} = -500 \text{ mA}$	250		
		$V_{CE} = -2.0 \text{ V}, I_{C} = -1.0 \text{ A}$	200		
		$V_{CE} = -2.0 \text{ V}, I_{C} = -2.0 \text{ A}$	150		
V _{CE} (sat)	Collector–Emitter Saturation Voltage (Note 4)	$I_C = -500 \text{ mA}, I_B = -5.0 \text{ mA}$		-0.25	V
		$I_C = -1.0 \text{ A}, I_B = -10 \text{ mA}$		-0.45	
		$I_C = -2.0 \text{ A}, I_B = -50 \text{ mA}$		-0.75	
V _{BE} (sat)	Base–Emitter Saturation Voltage (Note 4)	$I_C = -1.0 \text{ A}, I_B = -10 \text{ mA}$		-1.0	V
V _{BE} (on)	Base-Emitter On Voltage (Note 4)	$I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$		-1.0	V
f _T	Transition Frequency	$I_C = -50 \text{ mA}, V_{CE} = -5.0 \text{ V}, f = 50 \text{ MHz}$	100		MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
FZT790A	790A	SOT-223 (Pb-Free)	4,000 Units/ Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{4.} Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2.0%

FZT790A

TYPICAL PERFORMANCE CHARACTERISTICS

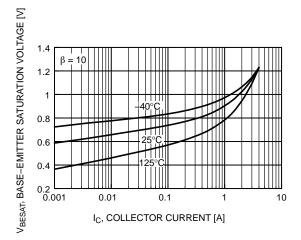


Figure 1. Base–Emitter Saturation Voltage vs. Collector Current

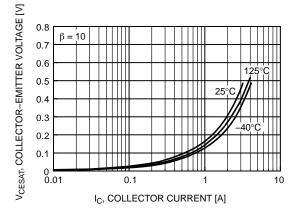


Figure 3. Collector–Emitter Saturation Voltage vs. Collector Current

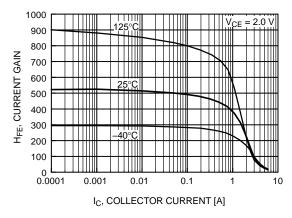


Figure 5. Current Gain vs. Collector Current

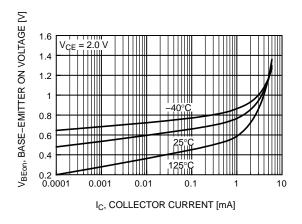


Figure 2. Base–Emitter On Voltage vs. Collector Current

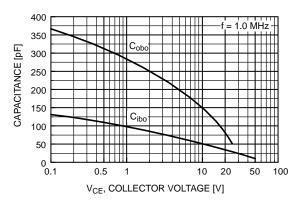


Figure 4. Input/Output Capacitance vs. Reverse Bias Voltage

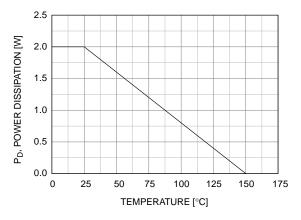


Figure 6. Power Dissipation vs. Ambient Temperature

SCALE 2:1

|△|0.10|C



A

В

NDTE 7

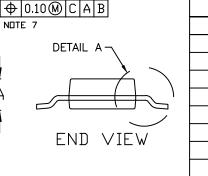
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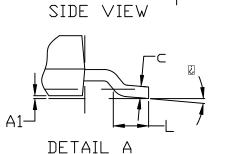
NOTES

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 Y14.5M, 2009.
 CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D & E1 ARE DETERMINED AT DATUM
 H. DIMENSIONS DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS DR GATE BURRS. SHALL NOT
 EXCEED 0.23mm PER SIDE.
 LEAD DIMENSIONS & AND &1 DO NOT INCLUDE
 DAMBAR PROTRUSION. ALLOWABLE DAMBBAR
 PROTRUSION IS 0.08mm PER SIDE.
 DATUMS A AND B ARE DETERMINED AT DATUM H.
 A1 IS DEFINED AS THE VERTICAL DISTANCE
 FROM THE SEATING PLANE TO THE LOWEST
 POINT OF THE PACKAGE BODY.
 POSITIONAL TOLERANCE APPLIES TO DIMENSIONS
 & AND &1.

- b AND b1.

	MILLIMETERS		
DIM	MIN.	N□M.	MAX.
Α			1.80
A1	0.02	0.06	0.11
b	0.60	0.74	0.88
b1	2.90	3.00	3.10
С	0.24		0.35
D	6.30	6.50	6.70
E	6.70	7.00	7.30
E1	3.30	3.50	3.70
е	2.30 BSC		
L	0.25		
į.	0°		10°

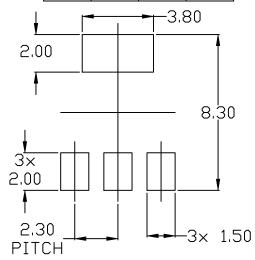




TOP VIEW

= Assembly Location **GENERIC MARKING DIAGRAM*** = Year = Work Week **W** XXXXX = Specific Device Code = Pb-Free Package AYW (Note: Microdot may be in either location) XXXXX=

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the IN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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